



钜地半导体
Tudi Semiconductor

Product Specification

TUDI-MAX4420/4429

High-Speed, 6A Single MOSFET Drivers

网址 www.sztdbdt.com 🔍

用芯智造 · 卓越品质

**semiconductor device
manufacturer**

- Design
- research and development
- production
- and sales



Features

- TTL/CMOS Compatible($I_{IN} \leq 10 \mu A$)
- 4.5V to 18V Supply Range(MAX4420/MAX4429)
- 1.5Ω Output Resistance
- 6A Peak Output Current
- 40ns Delay Time
- 25ns Rise and Fall Times(2500pF Load)
- Output Swings to within 25mV of V_{DD} and GND

Applications

Switching Power Supplies
DC-DC Converters
Motor Controllers
Pin-Diode Drivers

General Description

The MAX4420, MAX4429 and MXT429 are single-output MOSFET drivers designed to translate TTL/CMOS inputs to high-voltage/high-current outputs. The low 1.5Ω output impedance and 6A peak current output allow them to rapidly switch high-capacitance power MOSFETs, improving efficiency.

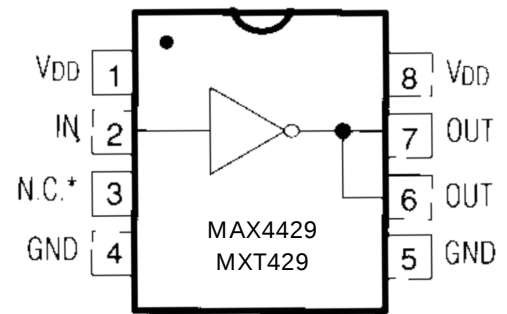
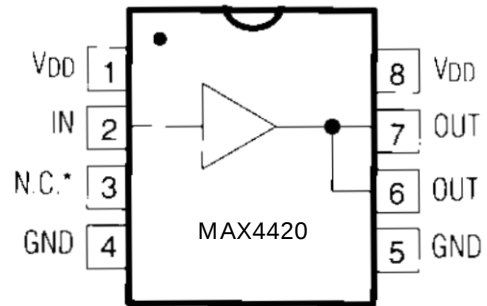
40ns delay time and a 25ns rise or fall time (while driving 2500pF to 18V) minimize power losses during MOSFET switching transitions.

The MAX4420/MAX4429/MXT429 interface easily with either CMOS or bipolar switch-mode controllers because their logic inputs draw under $10\mu A$. The outputs swing to within 25mV of GND or the power-supply rail, which can be 4.5V to 18V for the MAX4420/MAX4429, and 7V to 18V for the MXT429.

Power-supply quiescent current is typically $45\mu A$ and $450\mu A$ for logic input low and high, respectively. The MAX4420 has a non-inverting output. The MAX4429 and MXT429 have inverting outputs.

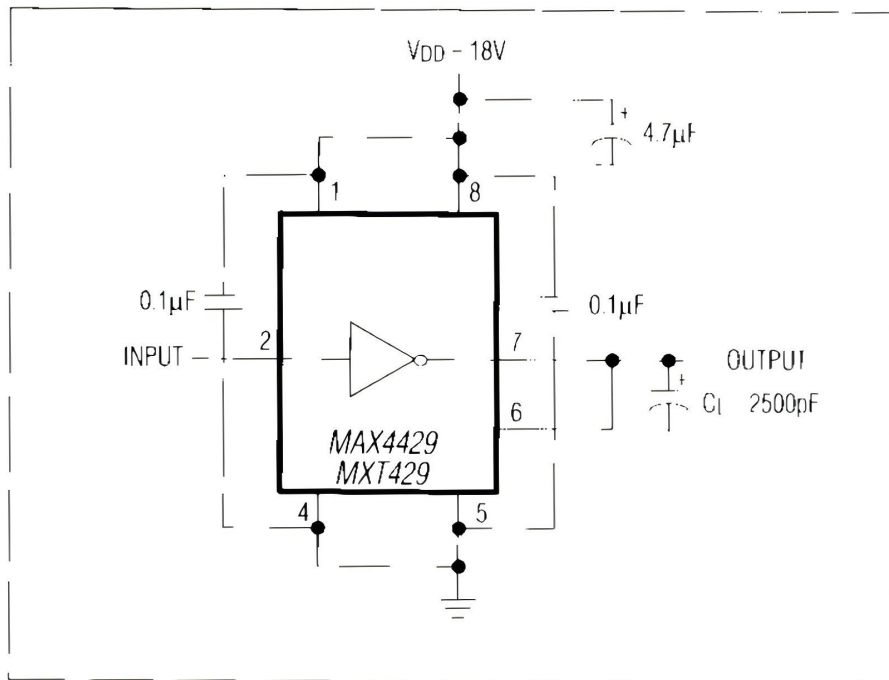
For dual drivers, refer to the MAX626/MAX627/MAX628 and MAX4426/MAX4427/MAX4428 data sheets.

TOP VIEW





Typical Operating Circuit





ABSOLUTE MAXIMUM RATINGS

Supply Voltage V_{DD} to GND +20V
 Input Voltage V_{IN} -0.3V to ($V_{DD} + 0.3V$)
 Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)
 Plastic DIP (derate 9.09mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 727mW
 SO (derate 5.88mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 471mW
 CERDIP (derate 8.00mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 640mW

Operating Temperature Ranges:

MAX442_C__, MXT429C__ 0°C to $+70^\circ\text{C}$
 MAX442_E__, MXT429E__ -40°C to $+85^\circ\text{C}$
 MAX442_MJA, MXT429MJA -55°C to $+125^\circ\text{C}$
 Storage Temperature Range -65°C to $+160^\circ\text{C}$
 Lead Temperature (soldering, 10sec) $+300^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(MAX4420/MAX4429 $V_{DD} = +4.5V$ to $+18V$, MXT429 $V_{DD} = +7V$ to $+18V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MAX4420/MAX4429			MXT429			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
Operating Range	V _{DD}			4.5		18	7		18	V
Power Supply Current	I _{DD}	V _{IN} = 3V	T _A = +25°C	0.45		1.5	0.45		5.0	mA
			T _A = T _{MIN} to T _{MAX}	3.0		12.0				
		V _{IN} = 0V	T _A = +25°C	0.045	0.150	0.045		0.5		
			T _A = T _{MIN} to T _{MAX}	0.400		1.0				
Logic 1 Input Voltage	V _{IH}			2.4		2.4			V	
Logic 0 Input Voltage	V _{IL}			0.8		0.8			V	
IN Leakage Current	I _{IN}	V _{IN} = 0V to V _{DD}		±10		±10			μA	
Output High Voltage	V _{OH}	No load		V _{DD} - 25		V _{DD} - 25			mV	
Output Low Voltage	V _{OL}	No load		25		25			mV	
Peak Output Current	I _{OUT}	V _{DD} = 18V	T _A = +25°C	6		6			A	
Output Resistance	R _{OUT}	V _{DD} = 18V, I _{OUT} = 10mA, V _{IN} = 0.8V or 2.4V	T _A = +25°C	1.5	2.5	1.5		2.5	Ω	
			T _A = T _{MIN} to T _{MAX}	5.0		5.0				
Rise Time (Note 1)	t _R	Figure 1	T _A = +25°C	25	30	25		35	ns	
			T _A = T _{MIN} to T _{MAX}	60		70				
Fall Time (Note 1)	t _F	Figure 1	T _A = +25°C	25	30	25		35	ns	
			T _A = T _{MIN} to T _{MAX}	60		70				
Delay Time (Note 1)	td1	Figure 1	T _A = +25°C	35	60	35		75	ns	
			T _A = T _{MIN} to T _{MAX}	100		100				
	td2	Figure 1	T _A = +25°C	40	60	40		75		
			T _A = T _{MIN} to T _{MAX}	100		120				

Note 1: Switching times guaranteed by design, not tested. See Figure 1 for timing measurement circuit, $V_{DD} = 18V$.

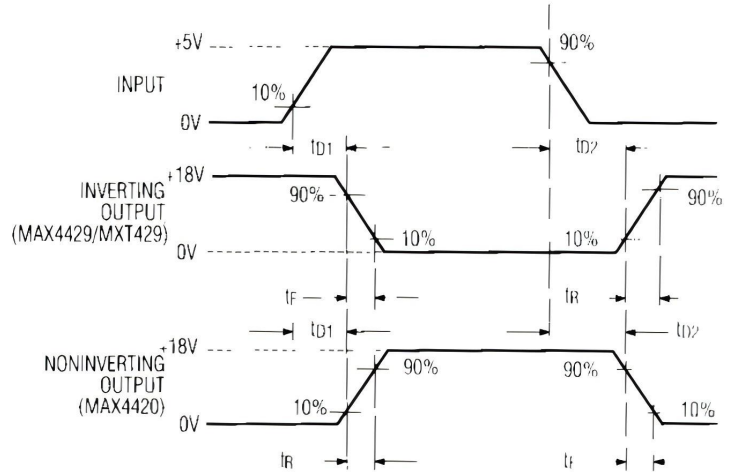
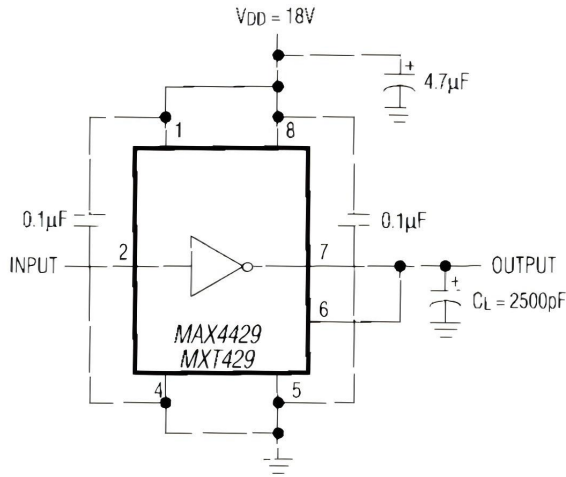


Figure 1. Switching-Time Measurement Circuit

Applications Information

The MAX4420/MAX4429/MXT429 have easy-to-drive inputs. However, the input must not be allowed to stay between V_{IH} and V_{IL} for more than 500ns. The power supply (V_{DD}) inputs must always be tied together, as should the outputs (OUT).

Supply bypassing and grounding are extremely important, as the peak supply and output currents can be greater than 6A. Ground drops are a form of negative feedback with inverters, and therefore will degrade the delay and transition time. Ringing may also be a problem with large $\Delta V/\Delta t$ and/or large AC currents.

Suggested bypass capacitors are a 4.7µF (low ESR) capacitor in parallel with 0.1µF ceramic capacitors, mounted as close as possible to the device. Use a ground plane if possible, or separate ground returns for inputs and outputs. Ringing can be minimized with a 5Ω resistor in series with the output, but this will degrade output transition time.

Power Dissipation

Power dissipation of the MAX4420/MAX4429/MXT429 consists of:

- 1) input inverter losses
- 2) crowbar current through the output devices
- 3) output current (either capacitive or resistive).

The sum of these must be kept below the maximum power-dissipation limit.

The DC input inverter losses are typically 45µA when the input is low and 450µA when the input is high.

The crowbar current through an output device making a transition is approximately 100mA for a few nanoseconds. This is a small portion of the total supply current, except for high switching frequencies or a small load capacitance (100pF).

The MAX4420/MAX4429/MXT429 power dissipation when driving a ground referenced resistive load is:

$$P = D \times R_{ON(max)} \times I_{LOAD}^2$$

where D is the percentage of time the MAX4420/MAX4429/MXT429 output pulls high, $R_{ON(max)}$ is the maximum on resistance of the device with the output high, and I_{LOAD} is the load current of the MAX4420/MAX4429/MXT429.

For capacitive loads, the power dissipation is:

$$P = C_{LOAD} \times V_{DD}^2 \times FREQ$$

where C_{LOAD} is the capacitive load, V_{DD} is the MAX4420/MAX4429/MXT429 supply voltage, and $FREQ$ is the toggle frequency.

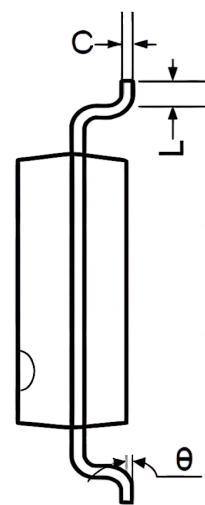
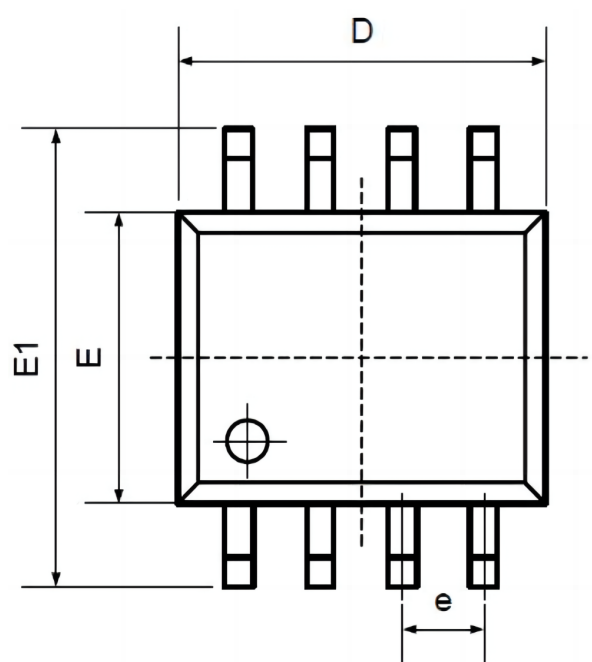


ORDERING INFORMATION

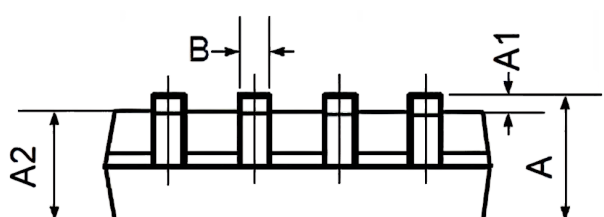
Order Number	Package	Package Quantity	Marking On The park
MAX4420CPA-TUDI	DIP8	Tube,50,A box of 2000	MAX4420CPA
MAX4420CSA-TUDI	SOP8	Tape,Reel,2500	MAX4420CSA
MAX4420EPA-TUDI	DIP8	Tube,50,A box of 2000	MAX4420EPA
MAX4420ESA-TUDI	SOP8	Tape,Reel,2500	MAX4420ESA
MAX4429CPA-TUDI	DIP8	Tube,50,A box of 2000	MAX4429CPA
MAX4429CSA-TUDI	SOP8	Tape,Reel,2500	MAX4429CSA
MAX4429EPA-TUDI	DIP8	Tube,50,A box of 2000	MAX4429EPA
MAX4429ESA-TUDI	SOP8	Tape,Reel,2500	MAX4429ESA



Package SOP8

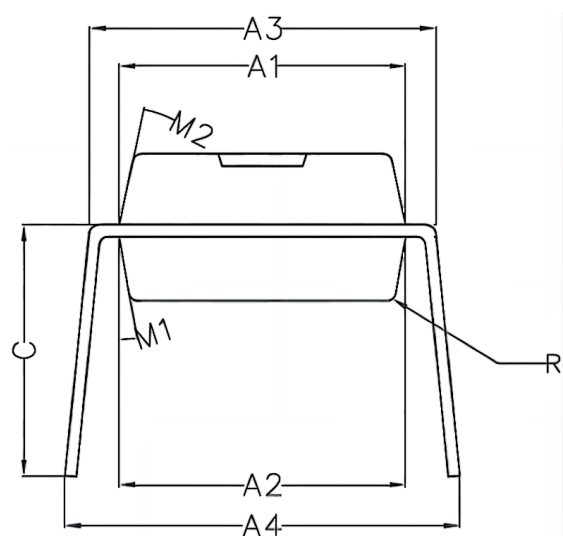
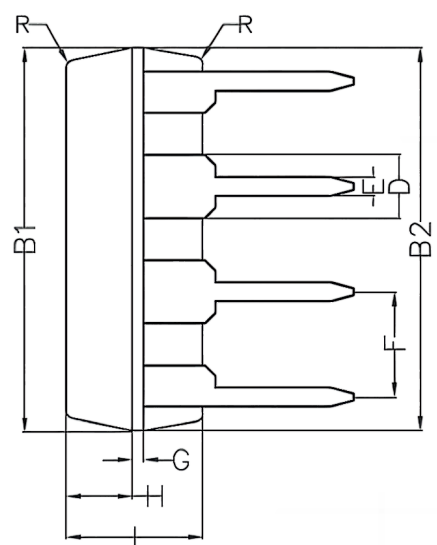
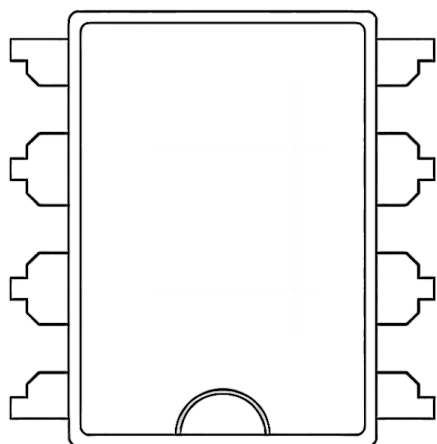


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
B	0.330	0.510	0.013	0.020
C	0.190	0.250	0.007	0.010
D	4.780	5.000	0.188	0.197
E	3.800	4.000	0.150	0.157
E1	5.800	6.300	0.228	0.248
e	1.270TYP		0.050TYP	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°





Package DIP8



Symbol	Min	Non	Max
A1	6.28	6.33	6.38
A2	6.33	6.38	6.43
A3	7.52	7.62	7.72
A4	7.80	8.40	9.00
B1	9.15	9.20	9.25
B2	9.20	9.25	9.30
C		5.57	
D		1.52	
E	0.43	0.45	0.47
F		2.54	
G		0.25	
H	1.54	1.59	1.64
I	3.22	3.27	3.32
R		0.20	
M1	9°	10°	11°
M2	11°	12°	13°



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